AUTOMOTIVE

RoHS

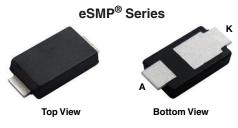
COMPLIANT

HALOGEN FREE



## Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



**SMPA (DO-221BC)** 



### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	8.0 A		
$V_{RRM}$	100 V		
I <sub>FSM</sub>	100 A		
$V_F$ at $I_F = 8.0 \text{ A } (T_A = 125 \text{ °C})$	0.62 V		
T <sub>J</sub> max.	175 °C		
Package	SMPA (DO-221BC)		
Circuit configuration	Single		

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL V8PAM10		UNIT	
Device marking code		8M10		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	100	V	
Maximum DC famuard accurant	I <sub>F(AV)</sub> (1)	8.0	А А	
Maximum DC forward current	I <sub>F(AV)</sub> (2)	2.9		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	100	А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +175	°C	

#### Notes

- (1) Units mounted on 3 cm x 3 cm aluminum PCB
- (2) Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 4.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.58	-	V
	$I_F = 8.0 A$			0.70	0.78	
	$I_F = 4.0 A$	T <sub>A</sub> = 125 °C		0.50	-	
	$I_F = 8.0 A$			0.62	0.70	
Reverse current	V <sub>R</sub> = 70 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	0.01	-	mA
	v <sub>R</sub> = 70 v	T <sub>A</sub> = 125 °C		2	-	
	V <sub>R</sub> = 100 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C		-	0.2	
	v <sub>R</sub> = 100 v	T <sub>A</sub> = 125 °C		4	10	
Typical junction capacitance	4.0 V, 1 MF	4.0 V, 1 MHz		810	-	pF

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq 5$  ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)				
PARAMETER SYMBOL V8PAM10			UNIT	
Typical thermal resistance	R <sub>0</sub> JA (1)(2)	100	°C/W	
i ypicai ilietitiai resistance	R <sub>θJM</sub> <sup>(3)</sup>	5		

#### **Notes**

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$
- (2) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance R<sub>θJA</sub> junction to ambient
- $^{(3)}$  Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance  $R_{\theta JM}$  junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8PAM10-M3/I	0.032	I	14 000	13" diameter plastic tape and reel	
V8PAM10HM3/I (1)	0.032	I	14 000	13" diameter plastic tape and reel	

### Note

(1) AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

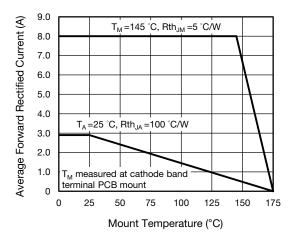


Fig. 1 - Maximum Forward Current Derating Curve

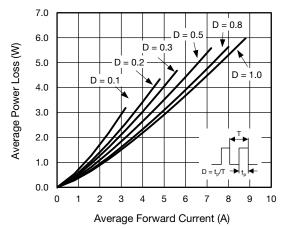


Fig. 2 - Forward Power Loss Characteristics



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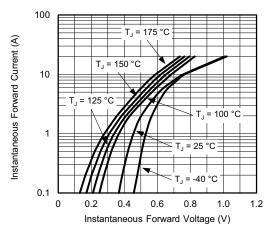


Fig. 3 - Typical Instantaneous Forward Characteristics

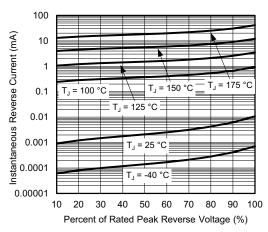


Fig. 4 - Typical Reverse Leakage Characteristics

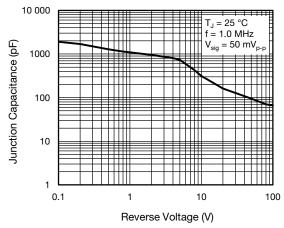


Fig. 5 - Typical Junction Capacitance

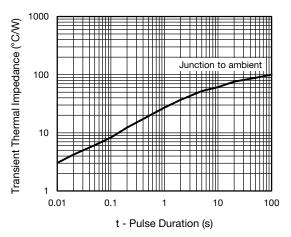


Fig. 6 - Typical Transient Thermal Impedance

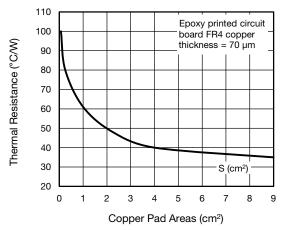


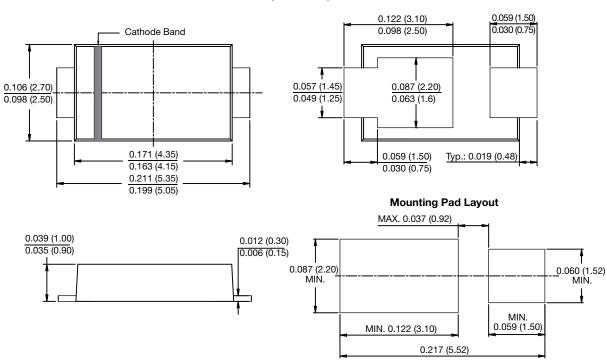
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### **SMPA (DO-221BC)**





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